

August 2015

FCPF1300N80Z N-Channel SuperFET[®] II MOSFET

800 V, 6 A, 1.3 Ω

Features

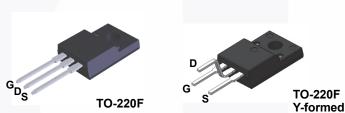
- R_{DS(on)} = 1.05 Ω (Typ.)
- Ultra Low Gate Charge (Typ. Q_g = 16.2 nC)
- Low E_{oss} (Typ. 1.57 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 48.7 pF)
- 100% Avalanche Tested
- RoHS Compliant
- ESD Improved Capability

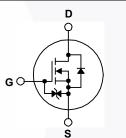
Applications

- AC DC Power Supply
- LED Lighting

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FCPF1300N80Z FCPF1300N80ZYD	Unit			
V _{DSS}	Drain to Source Voltage	800	V			
V _{GSS}	Cata ta Course Valtago	- DC	- DC		v	
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	V	
I _D	Drain Current	- Continuous (T _C = 25 ^o C)		6.0*	^	
	Drain Current	- Continuous (T _C = 100 ^o C)		3.8*	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	12*	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			48	mJ	
AR	Avalanche Current (Note 1)			0.8	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)			0.26	mJ	
dv/dt	MOSFET dv/dt	100	V/ns			
	Peak Diode Recovery dv/dt (Note 3)				20	
P _D	Devues Dissignation	(T _C = 25 ^o C)	$(T_{\rm C} = 25^{\rm o}{\rm C})$		W	
	Power Dissipation	- Derate Above 25°C		0.19	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
T _I	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

Symbol	Parameter	FCPF1300N80Z FCPF1300N80ZYD	Unit		
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	5.2	0000		
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W		

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Part Nu	Part Number Top Mark Pa		Package	Packing Method	Reel S	Size	Tape Wid	lth	Quantity	
		TO-220F			۱	N/A		50 units		
ECPE1300N80ZYD ECPE1300N80Z		TO-220F Y-formed	Lune	N/A		N/A		50 units		
Electrica	l Chara	cteristics T _C = 28	5°C unless o	otherwise noted.				1		
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit	
Off Charac	teristics									
BV _{DSS}	Drain to Source Breakdown Voltage			V _{GS} = 0 V, I _D = 1 mA, T _J = 25°C		800	-	-	V	
ΔBV_{DSS}		vn Voltage Temperature								
$/\Delta T_J$	Coefficier		I _D =	1 mA, Referenced to 2	25°C	-	0.85	-	V/ºC	
Zoro Catr		Voltage Drain Current		V _{DS} = 800 V, V _{GS} = 0 V		-	-	25		
IDSS	Zero Gate Voltage Drain Current		VDS	= 640 V, V _{GS} = 0 V,T _C	;= 125°C	-	-	250	μΑ	
I _{GSS}	Gate to B	ody Leakage Current	V _{GS}	s = ±20 V, V _{DS} = 0 V	1	-	-	±10	μA	
On Charac	teristics									
V _{GS(th)}	Gate Thre	reshold Voltage		$V_{GS} = V_{DS}, I_{D} = 0.4 \text{ mA}$		2.5	-	4.5	V	
R _{DS(on)}	Static Dra	ic Drain to Source On Resistance		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2 \text{ A}$		-	1.05	1.3	Ω	
9 _{FS}	Forward 7	rward Transconductance		$V_{DS} = 20 \text{ V}, I_D = 2 \text{ A}$		-	4.5	-	S	
Dynamic C	haractor	istics								
C _{iss}	Input Cap						661	880	pF	
C _{oss}		apacitance		V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz		_	22.3	30	pF	
C _{rss}		Transfer Capacitance	f = '			-	0.74	-	pF	
C _{oss}		Dutput Capacitance		V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz		-	11.4	-	pF	
C _{oss(eff.)}	Effective Output Capacitance			$V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$			48.7	-	pF	
Q _{g(tot)}		e Charge at 10V		s = 640 V, I _D = 4 A,		-	16.2	21	nC	
Q _{gs}	Gate to S	ource Gate Charge		$V_{GS} = 10 V$		-	3.5	-	nC	
Q _{gd}	Gate to D	rain "Miller" Charge			(Note 4)	-	6.8	-	nC	
ESR	Equivalen	quivalent Series Resistance		1 MHz		-	4	-	Ω	
Switching	Characte	eristics								
t _{d(on)}		Delay Time				-	14	38	ns	
t _r	Turn-On F		Vnr	V_{DD} = 400 V, I _D = 4 A, V_{GS} = 10 V, R _g = 4.7 Ω (Note 4)		-	8.3	27	ns	
t _{d(off)}		Delay Time				-	33	76	ns	
t _f	Turn-Off F					-	6	22	ns	
		Charactoristics	I		. ,		1			
I _s	urce Diode Characteristics			Forward Current		-	-	6	A	
I _{SM}	Maximum Pulsed Drain to Source Diod						-	12	A	
V _{SD}	Drain to Source Diode Forward Voltage			$_{\rm S}$ = 0 V, I _{SD} = 4 A		-	-	1.2	V	
t _{rr}		Recovery Time	-	$\frac{S}{S} = 0 \text{ V}, \text{ I}_{SD} = 4 \text{ A},$		-	275	-	ns	
Q _{rr}		Recovery Charge	$v_{GS} = 0 V, I_{SD} = 4 A,$ $dI_F/dt = 100 A/\mu s$		-	2.9	-	μC		

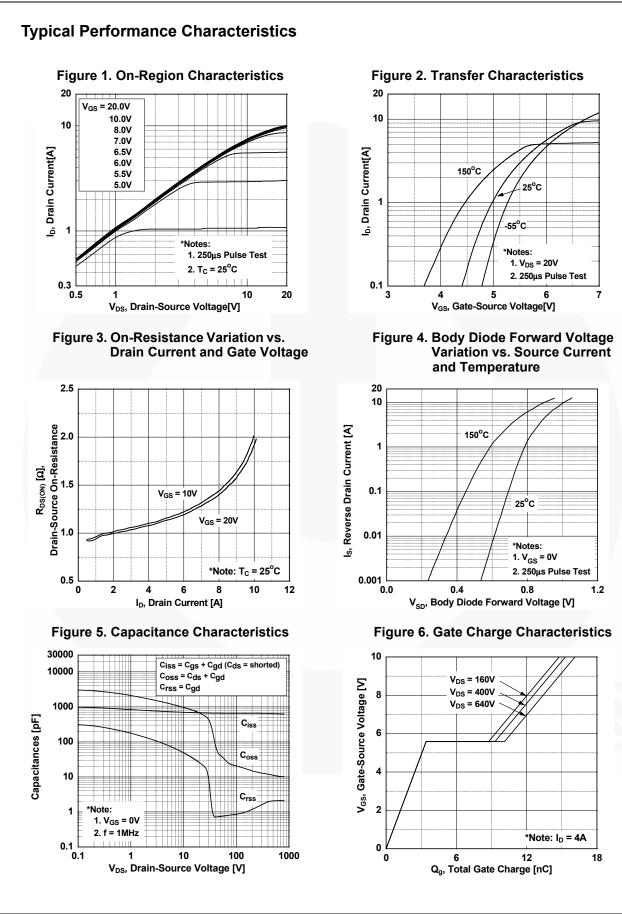
Q_{rr} Notes:

1. Repetitive rating: pulse width limited by maximum junction temperature.

2. I_{AS} = 0.8 A, R_G = 25 $\Omega_{\!\!,}$ starting T_J = 25°C

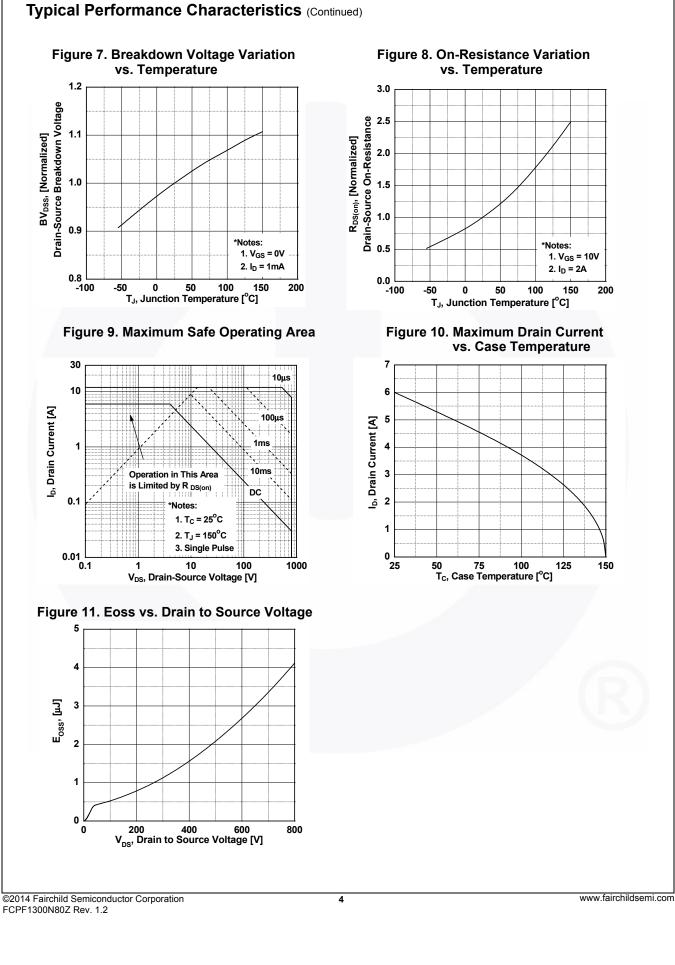
3. I_{SD} \leq 6 A, di/dt \leq 200 A/µs, V_{DD} \leq BV_{DSS}, starting T_J = 25^{\circ}C

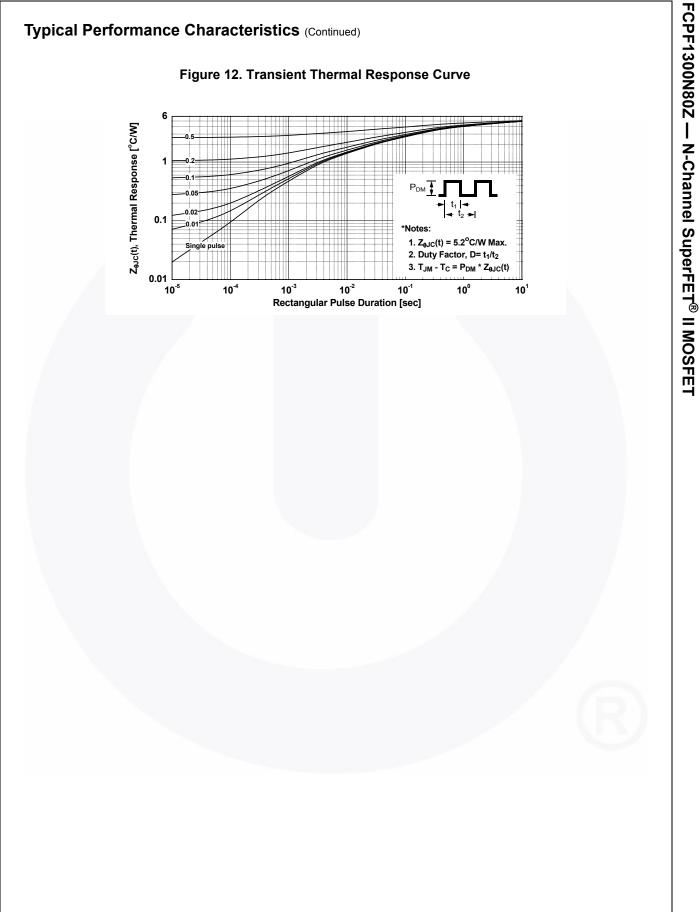
4. Essentially independent of operating temperature typical characteristic.

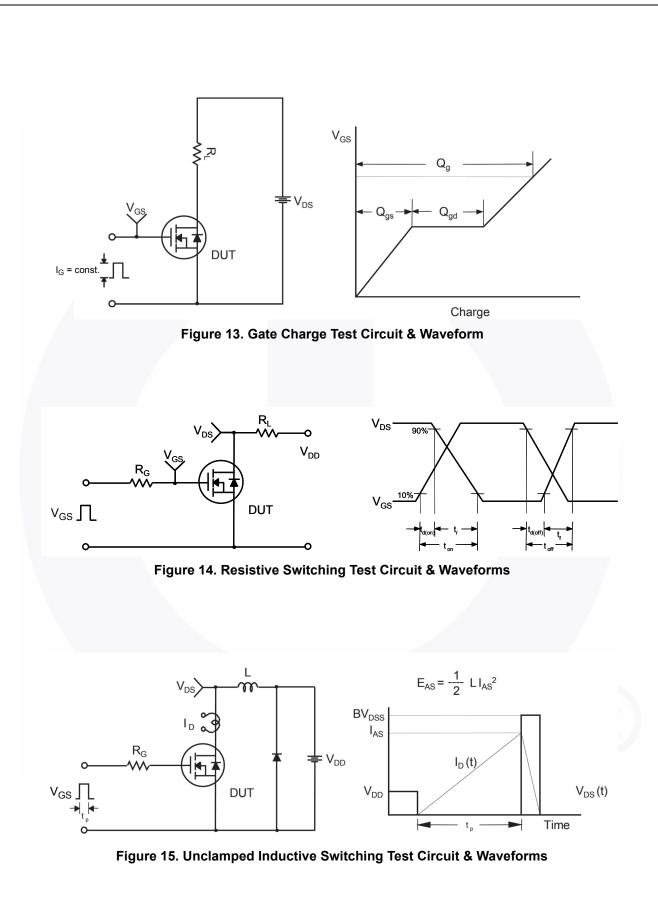


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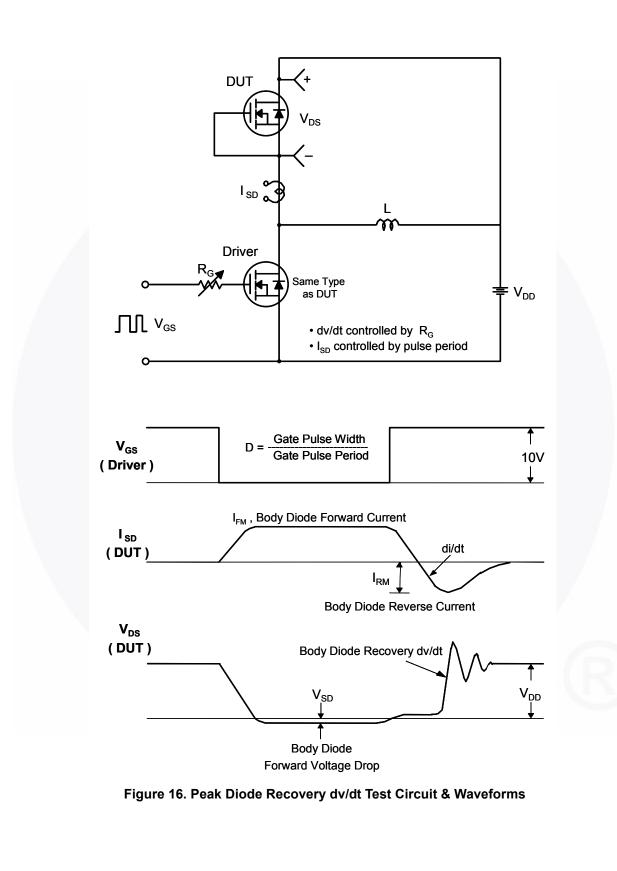


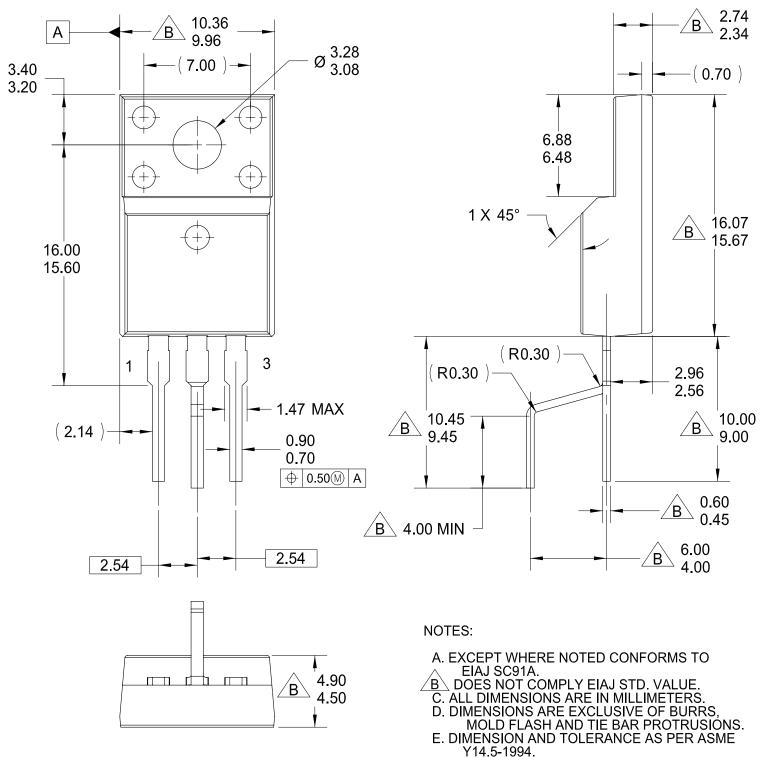




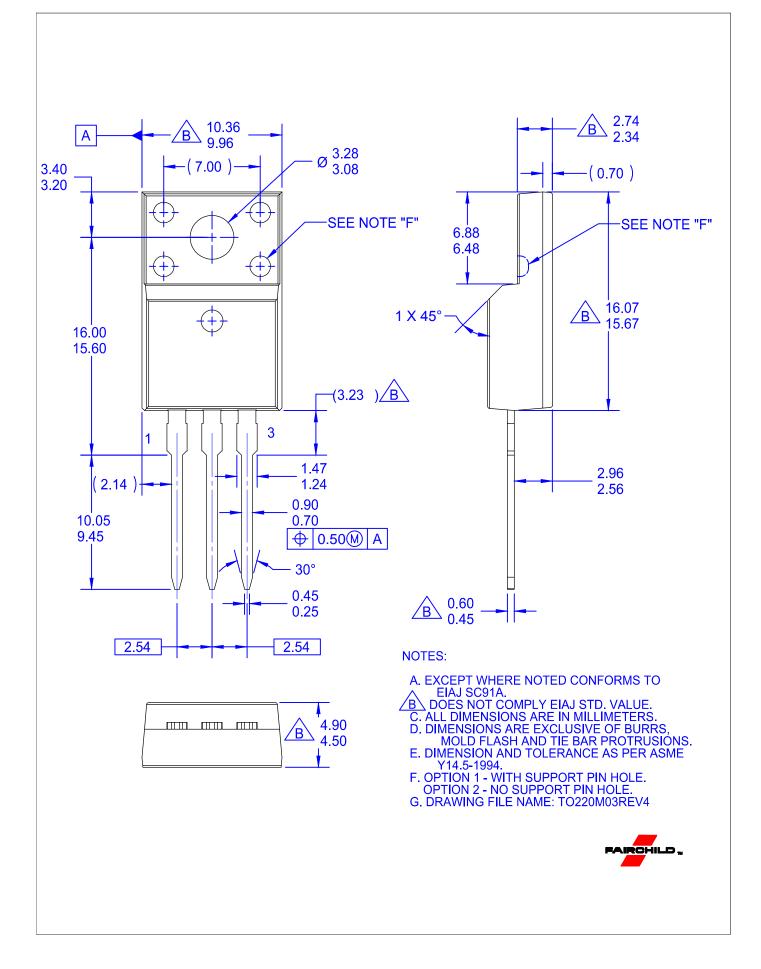


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